



**THE DATASHEET OF
TPS3803G15MDCKREP**



VOLTAGE DETECTOR

FEATURES

- **Controlled Baseline**
 - One Assembly/Test Site, One Fabrication Site
- **Extended Temperature Performance of Up to -55°C to $+125^{\circ}\text{C}$**
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product-Change Notification**
- **Qualification Pedigree⁽¹⁾**
- **Single Voltage Detector (TPS3803): Adjustable/1.5 V**
- **Dual Voltage Detector (TPS3805): Adjustable/3.3 V**
- **High $\pm 1.5\%$ Threshold Voltage Accuracy**
- **Supply Current: 3 μA Typical at $V_{\text{DD}} = 3.3 \text{ V}$**
- **Push/Pull Reset Output (TPS3805) Open-Drain Reset Output (TPS3803)**
- **5-Pin SC-70 Package**

(1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

APPLICATIONS

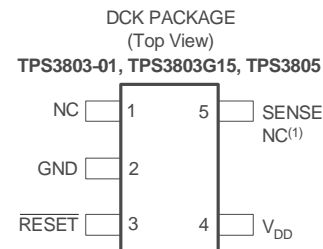
- **Applications Using DSPs, Microcontrollers, or Microprocessors**
- **Wireless Communication Systems**
- **Portable/Battery-Powered Equipment**
- **Programmable Controls**
- **Intelligent Instruments**
- **Industrial Equipment**
- **Notebook/Desktop Computers**
- **Automotive Systems**

DESCRIPTION

The TPS3803 and TPS3805 families of supervisory circuits provide circuit initialization and timing supervision, primarily for DSPs and processor-based systems.

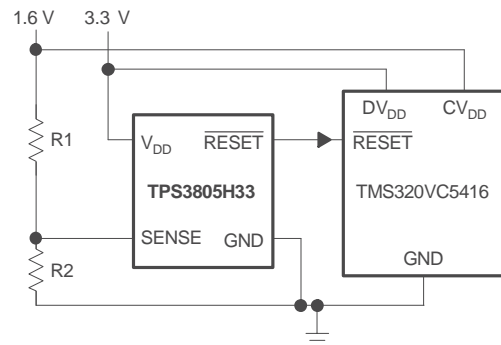
The TPS3803G15 device has a fixed-sense threshold voltage V_{IT} set by an internal voltage divider, whereas the TPS3803-01 has an adjustable SENSE input that can be configured by two external resistors. In addition to the fixed sense threshold monitored at V_{DD} , the TPS3805 devices provide a second adjustable SENSE input. $\overline{\text{RESET}}$ is asserted in case any of the two voltages drops below V_{IT} .

During power on, $\overline{\text{RESET}}$ is asserted when supply voltage V_{DD} becomes higher than 0.8 V. Thereafter, the supervisory circuit monitors V_{DD} (and/or SENSE) and keeps $\overline{\text{RESET}}$ active as long as V_{DD} or SENSE remains below the threshold voltage V_{IT} . As soon as V_{DD} (SENSE) rises above the threshold voltage V_{IT} , $\overline{\text{RESET}}$ is deasserted again. The product spectrum is designed for 1.5 V, 3.3 V, and adjustable supply voltages. The devices are available in a 5-pin SC-70 package.



(1) NC = No Connection on TPS3803G15

Typical Operating Circuit



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

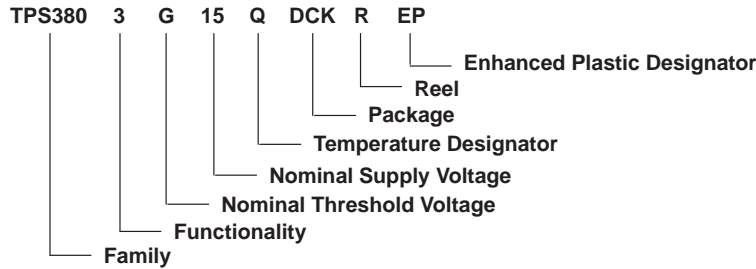
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE INFORMATION

T _A	DEVICE NAME	THRESHOLD VOLTAGE		MARKING
		V _{DD}	SENSE	
-40°C to +125°C	TPS3803-01QDCKREP(2)	NA	1.226 V	AWH
	TPS3803G15QDCKREP(2)	1.4 V	NA	AXT
	TPS3805H33QDCKREP(2)	3.05 V	1.226 V	AWY
-55°C to +125°C	TPS3803-01MDCKREP(2)	NA	1.226 V	BAY
	TPS3803G15MDCKREP(2)	1.40 V	NA	ARH
	TPS3805H33MDCKREP(2)	3.05 V	1.226 V	ARJ

(2) The DCKR passive indicates tape and reel containing 3000 parts.

ORDERING INFORMATION

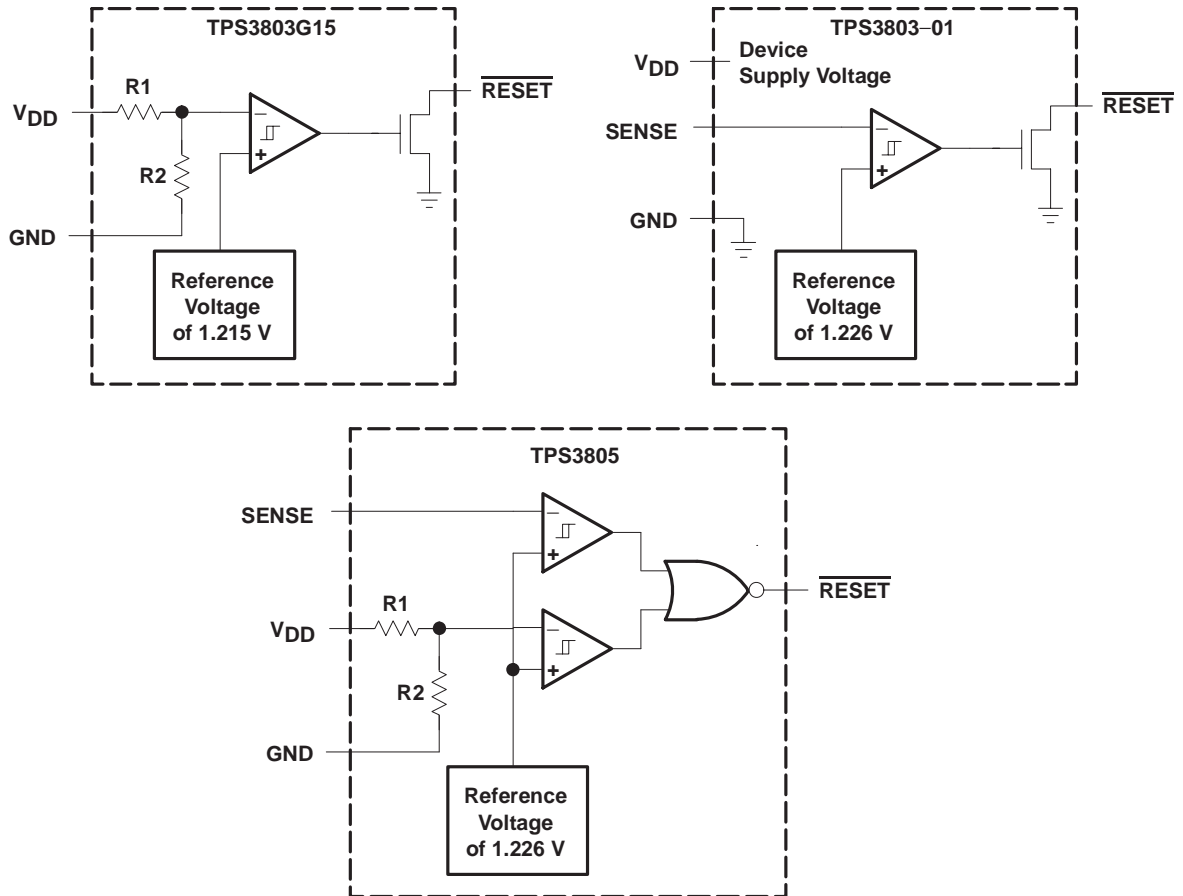


Function/Truth Tables

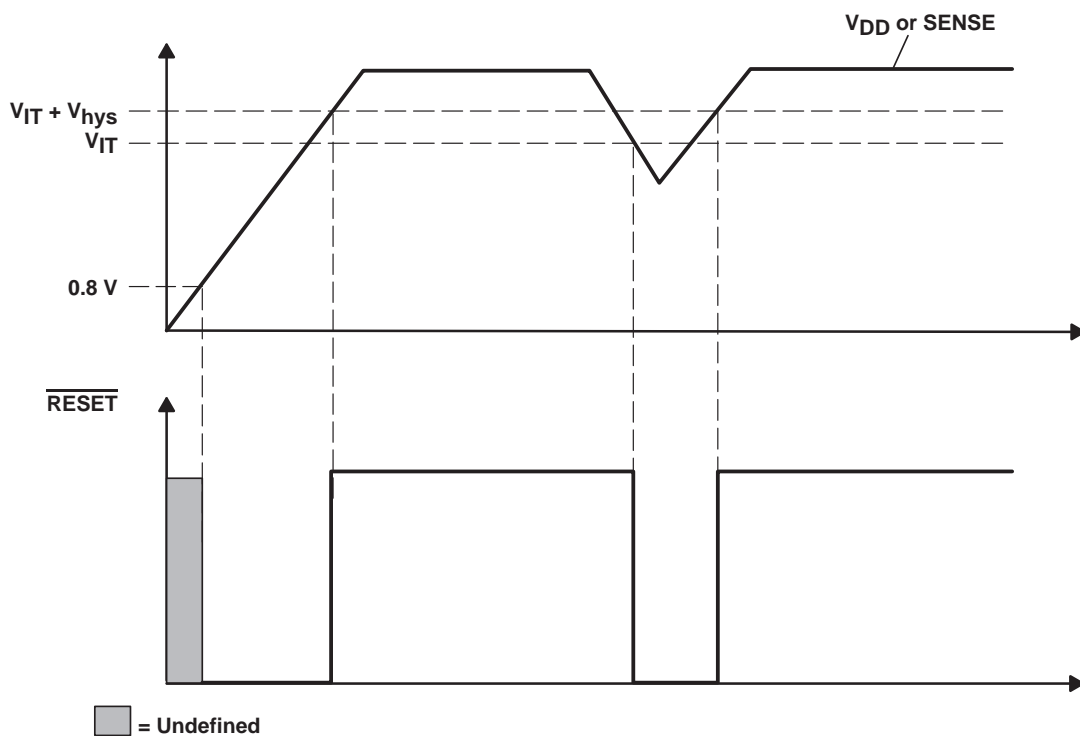
TPS3803-01		TPS3803G15	
SENSE > V _{IT}	RESET	V _{DD} > V _{IT}	RESET
0	L	0	L
1	H	1	H

TPS3805H33		
V _{DD} > V _{IT}	SENSE > V _{IT}	RESET
0	0	L
0	1	L
1	0	L
1	1	H

FUNCTIONAL BLOCK DIAGRAM



TIMING REQUIREMENTS



Terminal Functions

TERMINAL NAME	NO.	I/O	DESCRIPTION
GND	2	I	Ground
$\overline{\text{RESET}}$	3	O	Active-low reset output (TPS3803—open-drain, TPS3805—push/pull)
SENSE	5	I	Adjustable sense input
NC	1		No internal connection
NC (TPS3803G15)	5		No internal connection
V_{DD}	4	I	Input supply voltage, fixed sense input for TPS3803G15 and TPS3805

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Over operating free-air temperature, unless otherwise noted.

Supply voltage, V_{DD} ⁽²⁾	+7 V
All other pins ⁽²⁾	-0.3 V to +7 V
Maximum low-output current, I_{OL}	+5 mA
Maximum high-output current, I_{OH}	-5 mA
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{DD}$)	± 10 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{DD}$)	± 10 mA
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A	-55°C to +125°C
Storage temperature range, T_{stg} ⁽³⁾	-65°C to +150°C

(1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values are with respect to GND. For reliable operation the device should not be continuously operated at 7 V for more than $t = 1000$ h.

(3) Long-term high-temperature storage and/or extended use at maximum recommended operating conditions may result in a reduction of overall device life. See www.ti.com/ep_quality for additional information on enhanced plastic packaging.

DISSIPATION RATING TABLE

PACKAGE	$T_A < +25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = +25^\circ\text{C}$	$T_A = +70^\circ\text{C}$ POWER RATING	$T_A = +85^\circ\text{C}$ POWER RATING
DCK	321 mW	2.6 mW/°C	206 mW	167 mW

RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
Supply voltage, V_{DD}		1.3	6	V
Input voltage, V_I		0	$V_{DD} + 0.3$	V
Operating free-air temperature range, T_A	Q suffix devices	-40	+125	°C
	M suffix devices	-55	+125	

ELECTRICAL CHARACTERISTICS

Over recommended operating free-air temperature range, unless otherwise noted.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{OH}	High-level output voltage (TPS3805 only)	V _{DD} = 1.5 V, I _{OH} = -0.5 mA	0.8 x V _{DD}			V
		V _{DD} = 3.3 V, I _{OH} = -1 mA				
		V _{DD} = 6 V, I _{OH} = -1.5 mA				
V _{OL}	Low-level output voltage	V _{DD} = 1.5 V, I _{OL} = 1 mA	0.3			V
		V _{DD} = 3.3 V, I _{OL} = 2 mA				
		V _{DD} = 6 V, I _{OL} = 3 mA				
Power-up reset voltage(1)	V _{IT} > 1.5 V, T _A = +25°C	0.8				V
	V _{IT} ≤ 1.5 V, T _A = +25°C	1				V
V _{IT}	Negative-going input threshold voltage(2)	SENSE	1.2	1.226	1.244	V
		TPS3803G15	1.379	1.4	1.421	
		TPS3805H33	3.004	3.05	3.096	
V _{hys}	Hysteresis	1.2 V < V _{IT} < 2.5 V	15		mV	
		2.5 V < V _{IT} < 3.5 V	30			
I _I	Input current	SENSE	-25		25	nA
I _{OH}	High-level output current at $\overline{\text{RESET}}$	Open-drain only	V _{DD} = V _{IT} + 0.2V, V _{OH} = V _{DD}		300	nA
I _{DD}	Supply current	TPS3803-01	V _{DD} = 3.3 V, output unconnected	2	4	μA
		TPS3805, TPS3803G15		3	5	
		TPS3803-01	V _{DD} = 6 V, output unconnected	2	4	
		TPS3805, TPS3803G15		4	6	
C _I	Input capacitance	V _I = 0 V to V _{DD}	1			pF

(1) The lowest supply voltage at which $\overline{\text{RESET}}$ (V_{OL(max)} = 0.2 V, I_{OL} = 50 μA) becomes active. t_r(V_{DD}) ≥ 15 μs/V

(2) To ensure the best stability of the threshold voltage, place a bypass capacitor (ceramic, 0.1 μF) near the supply terminals.

TIMING REQUIREMENTS

AT R_L = 1 MΩ, C_L = 50 PF, over recommended operating free-air temperature range.

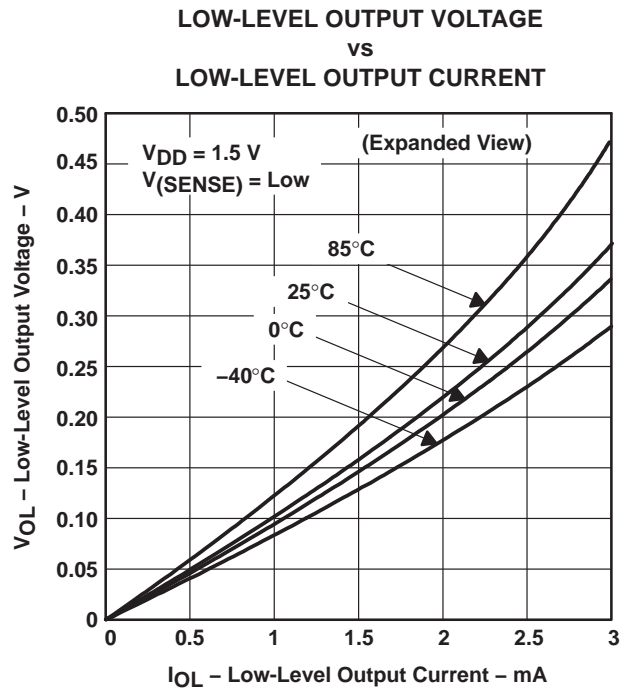
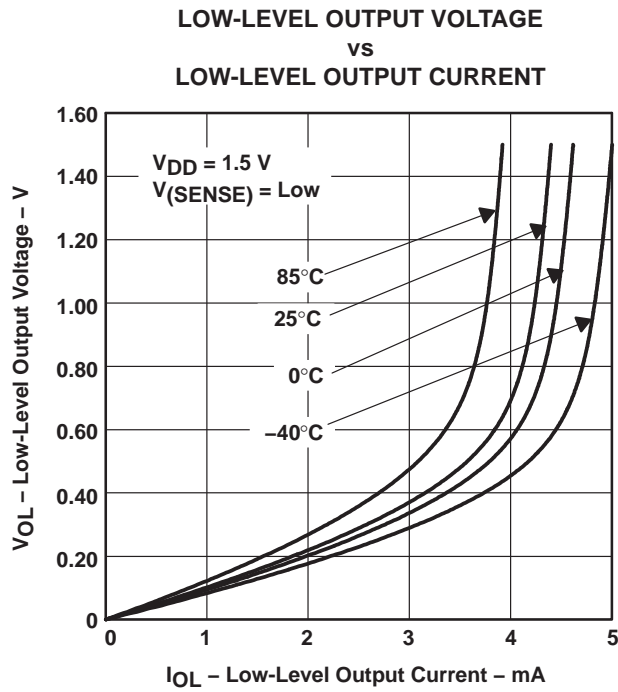
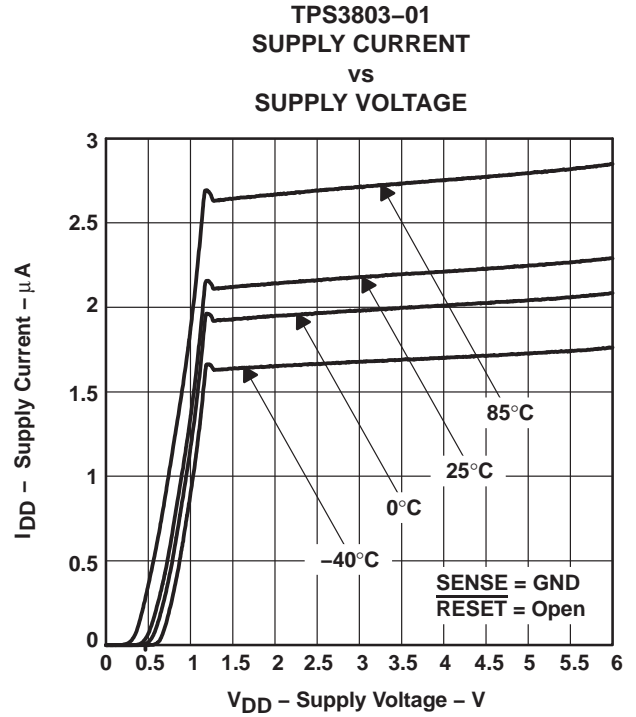
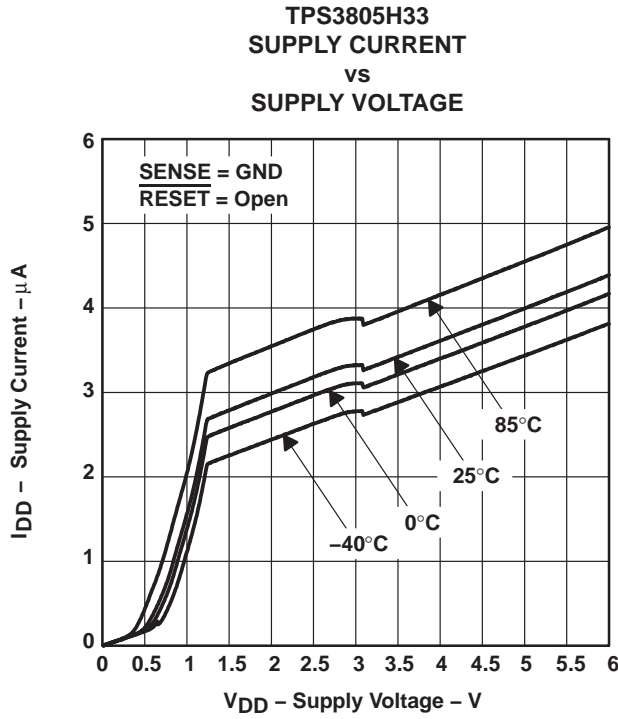
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _w	At V _{DD}	V _{IH} = 1.05 x V _{IT} , V _{IL} = 0.95 x V _{IT}	5.5			μs
	At SENSE					

SWITCHING CHARACTERISTICS

AT R_L = 1 MΩ, C_L = 50 PF, over recommended operating free-air temperature range.

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t _{PHL}	Propagation (delay) time, high-to-low-level output	V _{DD} to $\overline{\text{RESET}}$ delay	V _{IH} = 1.05 x V _{IT} , V _{IL} = 0.95 x V _{IT}	5	100	μs
		SENSE to $\overline{\text{RESET}}$ delay				
t _{PLH}	Propagation (delay) time, low-to-high-level output	V _{DD} to $\overline{\text{RESET}}$ delay	5	100		
		SENSE to $\overline{\text{RESET}}$ delay				

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

LOW-LEVEL OUTPUT VOLTAGE
 vs
 LOW-LEVEL OUTPUT CURRENT

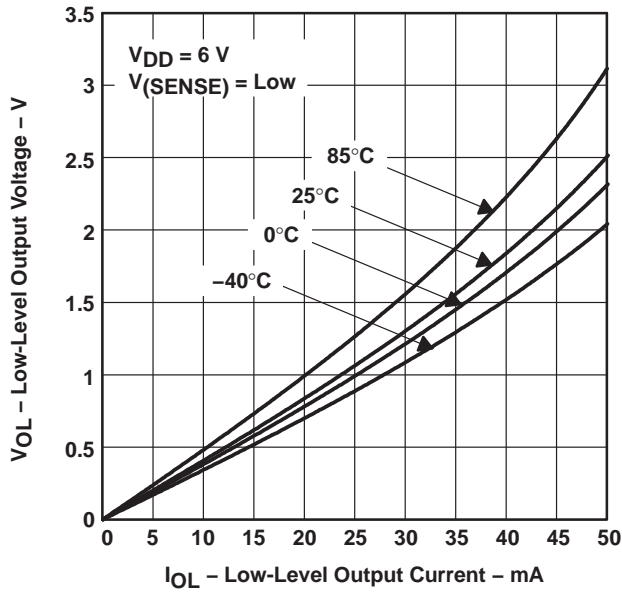


Figure 5

LOW-LEVEL OUTPUT VOLTAGE
 vs
 LOW-LEVEL OUTPUT CURRENT

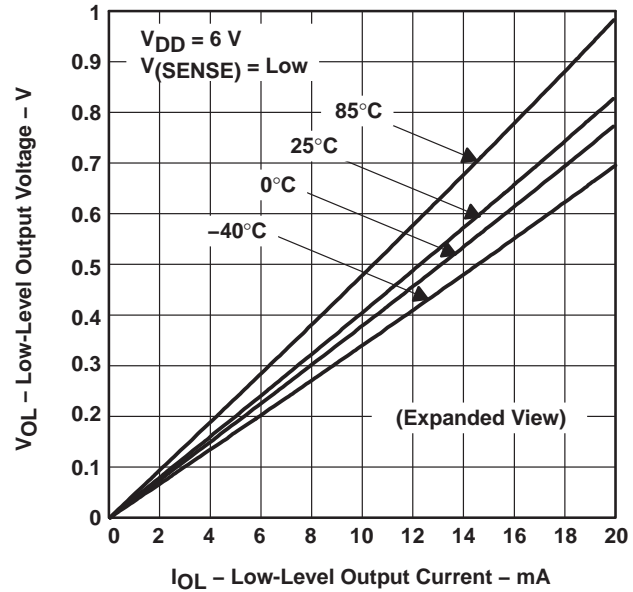


Figure 6

TPS3805H33
 HIGH-LEVEL OUTPUT VOLTAGE
 vs
 HIGH-LEVEL OUTPUT CURRENT

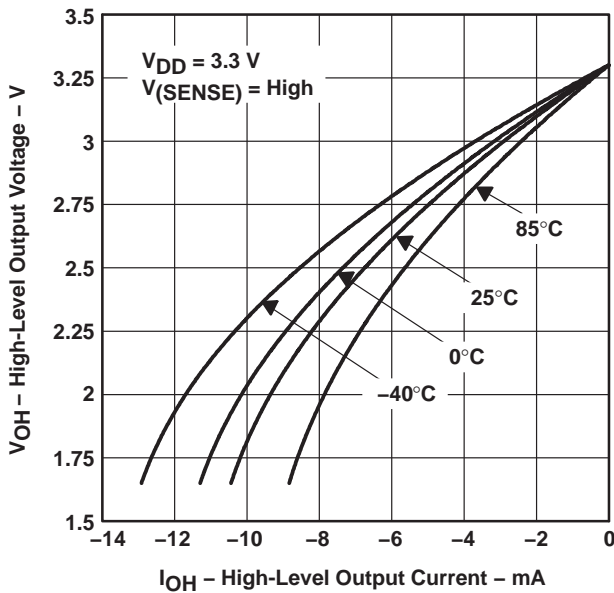


Figure 7

TPS3805H33
 HIGH-LEVEL OUTPUT VOLTAGE
 vs
 HIGH-LEVEL OUTPUT CURRENT

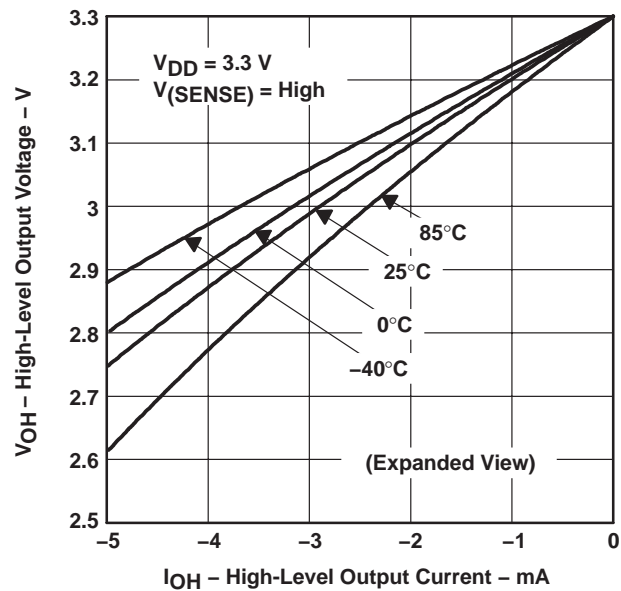


Figure 8

TYPICAL CHARACTERISTICS

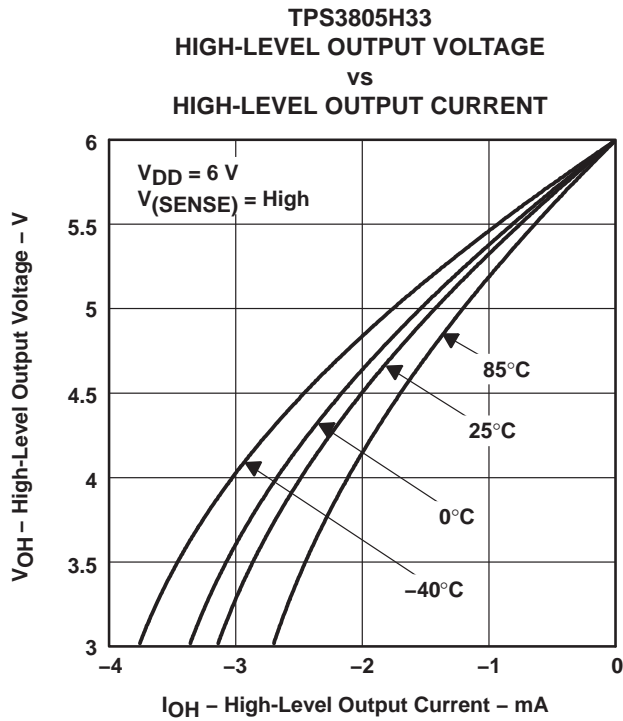


Figure 9

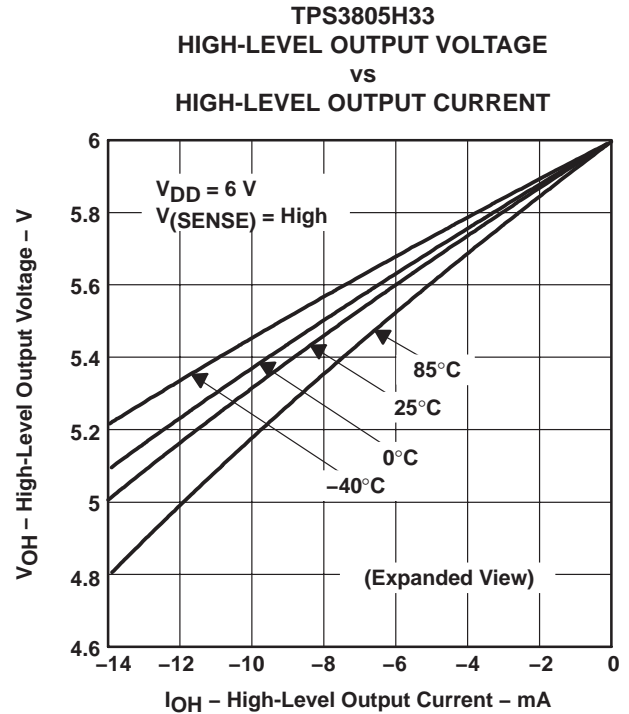


Figure 10

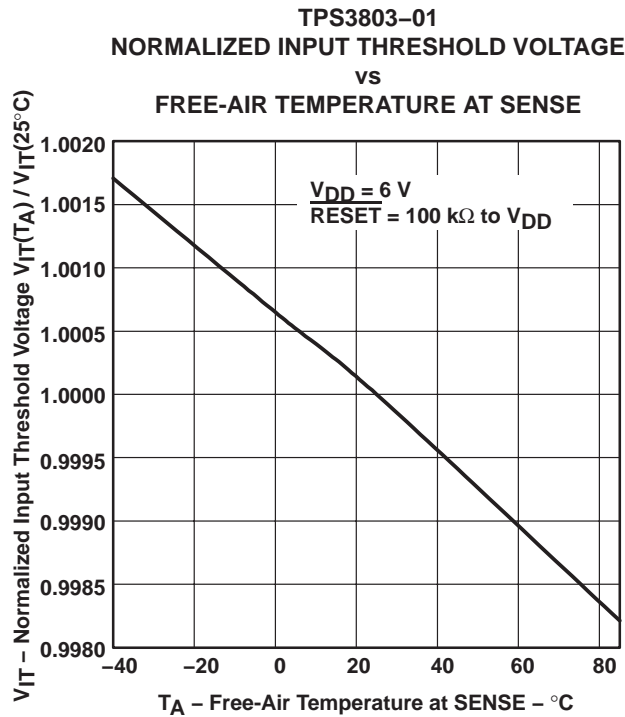


Figure 11

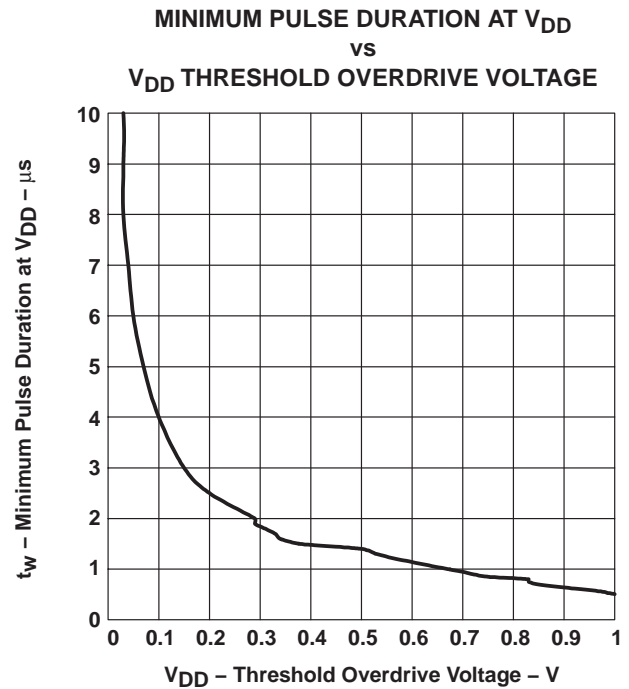


Figure 12

TYPICAL CHARACTERISTICS

MINIMUM PULSE DURATION AT SENSE
vs
SENSE THRESHOLD OVERDRIVE VOLTAGE

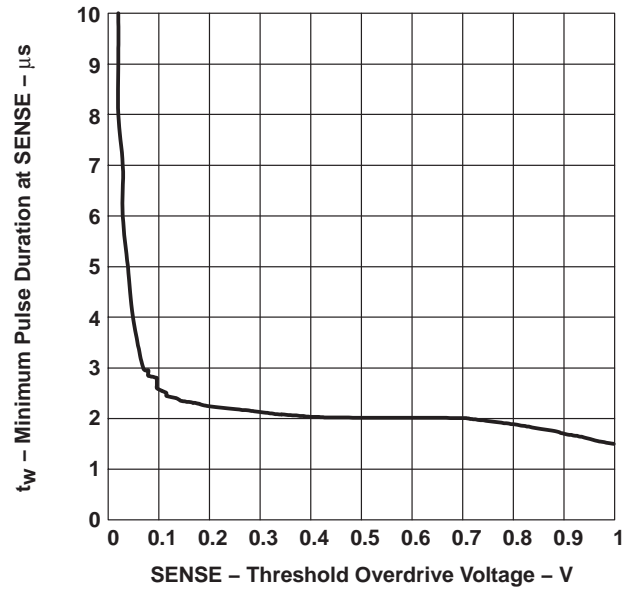


Figure 13

Revision History

DATE	REV	PAGE	SECTION	DESCRIPTION
6/07	C	Front Page	—	Updated front page.
		3	—	Functional block diagram change.

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TPS3803-01MDCKREP	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	BAY	Samples
TPS3803-01QDCKREP	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AWH	Samples
TPS3803G15MDCKREP	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-55 to 125	ARH	Samples
TPS3803G15QDCKREP	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	AXT	Samples
TPS3805H33MDCKREP	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-55 to 125	ARJ	Samples
TPS3805H33QDCKREP	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	AWY	Samples
V62/04648-01XE	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AWH	Samples
V62/04648-02XE	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	AXT	Samples
V62/04648-03XE	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	AWY	Samples
V62/04648-04XE	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	BAY	Samples
V62/04648-05XE	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-55 to 125	ARH	Samples
V62/04648-06XE	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-55 to 125	ARJ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TPS3803-01-EP, TPS3803-EP, TPS3803G15-EP, TPS3805H33-EP :

● Catalog: [TPS3803-01](#), [TPS3803](#), [TPS3803G15](#), [TPS3805H33](#)

● Automotive: [TPS3803-01-Q1](#), [TPS3803-Q1](#), [TPS3805H33-Q1](#)

NOTE: Qualified Version Definitions:

● Catalog - TI's standard catalog product

● Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS3803-01MDCKREP	SC70	DCK	5	3000	180.0	8.4	2.4	2.5	1.2	4.0	8.0	Q3
TPS3803-01QDCKREP	SC70	DCK	5	3000	180.0	8.4	2.4	2.5	1.2	4.0	8.0	Q3
TPS3803G15MDCKREP	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3803G15QDCKREP	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3805H33MDCKREP	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3805H33QDCKREP	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS3803-01MDCKREP	SC70	DCK	5	3000	202.0	201.0	28.0
TPS3803-01QDCKREP	SC70	DCK	5	3000	202.0	201.0	28.0
TPS3803G15MDCKREP	SC70	DCK	5	3000	202.0	201.0	28.0
TPS3803G15QDCKREP	SC70	DCK	5	3000	202.0	201.0	28.0
TPS3805H33MDCKREP	SC70	DCK	5	3000	202.0	201.0	28.0
TPS3805H33QDCKREP	SC70	DCK	5	3000	202.0	201.0	28.0

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-203 variation AA.

DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
 - Publication IPC-7351 is recommended for alternate designs.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

IMPORTANT NOTICE

Texas Instruments Incorporated (TI) reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete.

TI's published terms of sale for semiconductor products (<http://www.ti.com/sc/docs/stdterms.htm>) apply to the sale of packaged integrated circuit products that TI has qualified and released to market. Additional terms may apply to the use or sale of other types of TI products and services.

Reproduction of significant portions of TI information in TI data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such reproduced documentation. Information of third parties may be subject to additional restrictions. Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyers and others who are developing systems that incorporate TI products (collectively, "Designers") understand and agree that Designers remain responsible for using their independent analysis, evaluation and judgment in designing their applications and that Designers have full and exclusive responsibility to assure the safety of Designers' applications and compliance of their applications (and of all TI products used in or for Designers' applications) with all applicable regulations, laws and other applicable requirements. Designer represents that, with respect to their applications, Designer has all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. Designer agrees that prior to using or distributing any applications that include TI products, Designer will thoroughly test such applications and the functionality of such TI products as used in such applications.

TI's provision of technical, application or other design advice, quality characterization, reliability data or other services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using TI Resources in any way, Designer (individually or, if Designer is acting on behalf of a company, Designer's company) agrees to use any particular TI Resource solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

Designer is authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY DESIGNER AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Unless TI has explicitly designated an individual product as meeting the requirements of a particular industry standard (e.g., ISO/TS 16949 and ISO 26262), TI is not responsible for any failure to meet such industry standard requirements.

Where TI specifically promotes products as facilitating functional safety or as compliant with industry functional safety standards, such products are intended to help enable customers to design and create their own applications that meet applicable functional safety standards and requirements. Using products in an application does not by itself establish any safety features in the application. Designers must ensure compliance with safety-related requirements and standards applicable to their applications. Designer may not use any TI products in life-critical medical equipment unless authorized officers of the parties have executed a special contract specifically governing such use. Life-critical medical equipment is medical equipment where failure of such equipment would cause serious bodily injury or death (e.g., life support, pacemakers, defibrillators, heart pumps, neurostimulators, and implantables). Such equipment includes, without limitation, all medical devices identified by the U.S. Food and Drug Administration as Class III devices and equivalent classifications outside the U.S.

TI may expressly designate certain products as completing a particular qualification (e.g., Q100, Military Grade, or Enhanced Product). Designers agree that it has the necessary expertise to select the product with the appropriate qualification designation for their applications and that proper product selection is at Designers' own risk. Designers are solely responsible for compliance with all legal and regulatory requirements in connection with such selection.

Designer will fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of Designer's non-compliance with the terms and provisions of this Notice.

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

⊖ [View TPS3803G15MDCKREP](#) on WIN SOURCE

⊖ [Texas Instruments](#) Information

Optimize Your Supply Chain with WIN SOURCE Solutions

- ✓ Global Sourcing Solution
- ✓ Obsolete Management
- ✓ Cost Control Management
- ✓ Shortage Management
- ✓ Alternative Solution
- ✓ Excess Inventory Management